# TYS40201R0N-10

#### PHYSICAL DIMENSIONS:

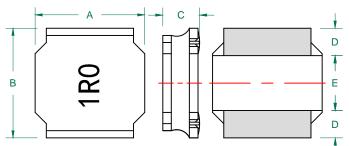
 $A 4.00 \pm 0.20$ 

 $B = 4.00 \pm 0.20$ 

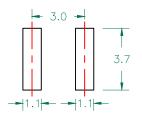
C 2.00 MAX.

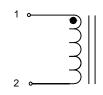
 $0.95 \pm 0.20$ 

 $F = 2.10 \pm 0.20$ 



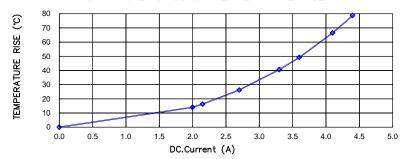
### LAND PATTERNS FOR REFLOW SOLDERING

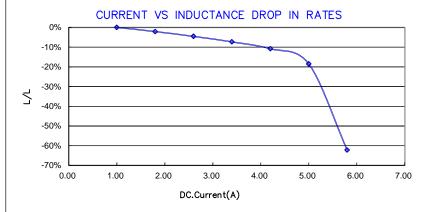




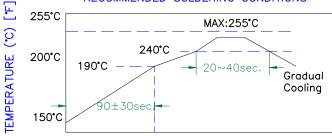


#### CHARACTERISTICS OF TEMPERATURE RISE





#### RECOMMENDED SOLDERING CONDITIONS



#### **ELECTRICAL SPECIFICATION**

	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/1V ± 30%	0.70	1.00	1.30
DCR (Ω)		0.029	0.0377

Saturation Current(A)	4.78
SRF (MHz)	75
Temperature Rise Current (A)	2.15

## DOCUMENT

**UNCONTROLLED** 

NOTES: UNLESS OTHERWISE SPECIFIED

1.OPERATING TEMPERATURE RANGE: -40°C TO +125°C (INCLUDING SELF-HEATING) .

2.STORAGE TEMPERATURE RANGE (PACKAGING CONDITIONS): -10°C TO +40°C AND RH 70% (MAX.)

3.UNLESS OTHERWISE SPECIFIED, THE STANDARD ATMOSPHERIC CONDITIONS FOR MEASUREMENT/TEST AS: A. AMBIENT TEMPERATURE: 20±15°C.

B. RELATIVE HUMIDITY: 65%±20%.

4.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS ≤30% FROM ITS VALUE WITHOUT CURRENT.

5.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE (  $\Delta T \leq 40\,^{\circ}\!\text{C}$  ) FROM 20°C AMBIENT.

DIMENSIONS ARE IN mm .			This print is the property of Laird							
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						PART TYP	or.	DRAWN BY:		
				'				DRAWN DI.		
				TYS40201R0N-10	В	POV		QIU		
	OULANDE LOOP	00 /00 /45	0111			INDO				
В	CHANGE LOGO	08/06/15	QU	DATE: 09/06/12 SCA	LE: N	ts I	SHEET:			
Α	ORIGINAL DRAFT	09/06/12	QIU	CAD #   TOO		-3				
REV	DESCRIPTION	DATE	INT	TYS40201R0N-10-B	٠,	-	1	of 1		